### **Field Effect Transistor**

Silicon N Channel MOS Type ( $\pi$ -MOS II) High Speed, High Current DC-DC Converter, Relay Drive and Motor Drive Applications

#### **Features**

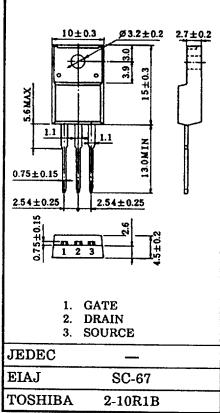
- · 4-Volt Gate Drive
- Low Drain-Source ON Resistance
  - $R_{DS(ON)} = 0.95\Omega$  (Typ.)
- High Forward Transfer Admittance
  - $|Y_{fs}| = 4.0S$  (Typ.)
- Low Leakage Current
  - $I_{DSS} = 300\mu A \text{ (Max.) } @ V_{DS} = 600V$
- Enhancement-Mode
  - $V_{th} = 1.5 \sim 3.5 V @ V_{DS} = 10 V$ ,  $I_D = 1 mA$

### Absolute Maximum Ratings (Ta = 25°C)

		SYMBOL	RATING	UNIT	
		V <sub>DSS</sub>	600		
			600	٧	
Gate-Source Voltage		V <sub>GSS</sub>	±30	٧	
Drain Current	DC	I <sub>D</sub>	6	Α	
	Pulse	I <sub>DP</sub>	24		
Drain Power Dissipation (Tc = 25°C)	<u>,</u>	P <sub>D</sub>	45	W	
Channel Temperature		T <sub>ch</sub>	150	°C	
Storage Temperature Range		T <sub>stg</sub>	-55 ~ 150	°C	

# Industrial Applications

Unit in mm



Weight: 1.9g

### **Thermal Characteristics**

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	R <sub>th(ch-c)</sub>	2.77	°C/W
Thermal Resistance, Channel to Ambient	R <sub>th(ch-a)</sub>	62.5	°C/W

This transistor is an electrostatic sensitive device. Please handle with care.

### Electrical Characteristics (Ta = 25°C)

CHAR	ACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage C	urrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±25V, V <sub>DS</sub> = 0V	-		±100	nΑ
Drain Cut-off C	Cut-off Current I <sub>DSS</sub> V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V		V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V	-	-	300	μА
Drain-Source B	reakdown Voltage	V <sub>(BR) DSS</sub>	I <sub>D</sub> = 10mA, V <sub>GS</sub> = 0V	600	_	-	٧
Gate Threshold	Voltage	V <sub>th</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA	1.5	-	3.5	٧
Drain-Source O	N Resistance	R <sub>DS (ON)</sub>	I <sub>D</sub> = 3A, V <sub>GS</sub> = 10V	-	0.95	1.25	Ω
Forward Transfe	er Admittance	Y <sub>ts</sub> I	$V_{DS} = 10V, I_{D} = 3A$	3.0	4.0	-	S
Input Capacitance $C_{iss}$ Reverse Transfer Capacitance $C_{rss}$ $V_{DS} = 10V, V_{GS} = 0V, f = 1MHz$			-	1400	2000		
		C <sub>rss</sub>		_	75	120	pF
Output Capacitance		Coss		-	250	380	
, ,	Rise Time	t <sub>r</sub>	VGS <sup>10V</sup> ID=3A VOUT	_	25	50	ns
Switching	Turn-on Time	t <sub>on</sub>		-	40	80	
Time	Fall Time	t <sub>i</sub>		_	20	40	
	Turn-off Time	t <sub>off</sub>	$V_{IN}: t_r, t_f < 5ns, V_{DD} = 300V$ $Duty \le 1\%, t_w = 10\mu s$	_	85	170	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Qg	V <sub>DD</sub> = 400V, V <sub>GS</sub> = 10V,	-	56	110	
Gate-Source Charge		Q <sub>gs</sub>	⊣ I <sub>D</sub> = 6A		32	-	пС
Gate-Drain ("Miller") Charge		Q <sub>gd</sub>	1		24	-	

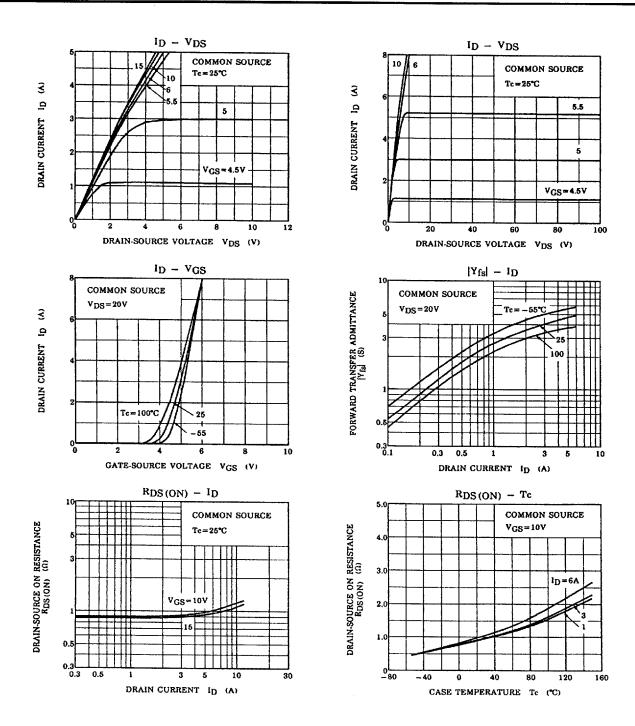
## Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

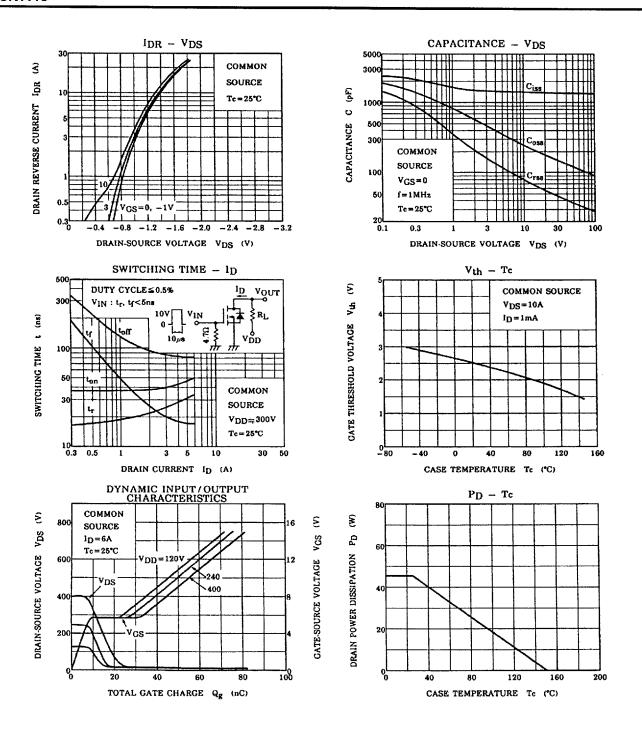
CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I <sub>DR</sub>	-	-		6	A
Pulse Drain Reverse Current	I <sub>DRP</sub>	-	-	-	24	A
Diode Forward Voltage	V <sub>DSF</sub>	I <sub>DR</sub> = 6A, V <sub>GS</sub> = 0V	-		-2.0	٧
Reverse Recovery Time	t <sub>rr</sub>	I <sub>DR</sub> = 6A, V <sub>GS</sub> = 0V	-	460	_	ns
Reverse Recovered Charge	Qrr	dl <sub>DR</sub> /dt = 100A/µs	_	3.5	-	μC

2/6

TOSHIBA CORPORATION

**=** 9097250 0021596 082 **=** 





4/6

TOSHIBA CORPORATION

**9097250 0021598 955** 

